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ICS 31.260
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SJ

INDUSTRY STANDARD OF THE PEOPLE'S REPUBLIC OF CHINA

SJ/T 11734-2019

Detailed Specification of Chip Scale Package (CSP) LED Blank

芯片级封装（CSP）LED空白详细规范

(English Translation)

Implemented on: April 1, 2020

Issued by: Ministry of Industry and Information Technology

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1 Foreword

SJ/T 11734-2019 was issued by Ministry of Industry and Information Technology on 11 November 2019 and has been in force since 1 April 2020.

The SJ/T prefix marks a recommended standard. It is not law in itself: it becomes binding when a contract names it, when a regulation or a mandatory standard refers to it, or when a producer declares conformity with it.

The document runs to 11 pages in English translation.

2 Scope Preview

This standard specifies the technical requirements for chip-scale package (CSP) LEDs, including general requirements, limit values, optoelectronic characteristics, test conditions and methods, and inspection requirements for COB LEDs.

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SJ/T 11734-2019 falls under ICS 31.260, in the field of electronics.

This catalogue holds 221 other SJ/T standards in that field.

In this catalogue, SJ/T standards carry edition years from 1980 to 2026.

3 About this standard

Sector: Electronics Industry Standard (Recommended)

Issued by: Ministry of Industry and Information Technology

English translation: about 11 pages (approximate)

Chinese original: about 17,161 characters

4 Related standards

Standards on related subjects:

GB/T 43770-2024 - Specification for indoor LED displays

GB/T 15651.7-2024 - Semiconductor devices - Part 5-7: Optoelectronic devices - Photodiodes and phototransistors

SJ/T 11890-2023 - Design requirement of energy conservation for LED displays

SJ/T 11733-2019 - Detailed Specification of COB LED Blank

5 Classification and status

International classification (ICS): 31.260

Chinese Standard Classification (CCS): L 53

Prefix SJ/T: recommended standard.

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